Hyper TOPLED®
White LED

LW T676

Besondere Merkmale

- **Gehäusetyp:** weißes P-LCC-2 Gehäuse
- **Besonderheit des Bauteils:** extrem breite Abstrahlcharakteristik; ideal für Hinterleuchtungen und Einkopplungen in Lichtleiter
- **Farbort:** x = 0,30, y = 0,32 nach CIE 1931 (weiß)
- **typische Farbtemperatur:** 7300 K
- **Farbwiedergabeindex:** 80
- **Abstrahlwinkel:** extrem breite Abstrahlcharakteristik (120°)
- **Technologie:** GaN
- **optischer Wirkungsgrad:** 2 lm/W
- **Gruppierungsparameter:** Lichtstärke, Farbort
- **Verarbeitungsmethode:** für alle SMT-Bestücktechniken geeignet
- **Lötmethode:** IR Reflow Löten und Wellenlöten (TTW)
- **Vorbehandlung:** nach JEDEC Level 2
- **Gurtung:** 8 mm Gurt mit 2000/Rolle, ø180 mm oder 8000/Rolle, ø330 mm
- **ESD-Festigkeit:** ESD-sicher bis 2 kV nach EOS/ESD-5.1-1993

Features

- **package:** white P-LCC-2 package
- **feature of the device:** extremely wide viewing angle; ideal for backlighting and coupling in light guides
- **color coordinates:** x = 0.30, y = 0.32 acc. to CIE 1931 (white)
- **typ. color temperature:** 7300 K
- **color reproduction index:** 80
- **viewing angle:** extremely wide (120°)
- **technology:** GaN
- **optical efficiency:** 2 lm/W
- **grouping parameter:** luminous intensity, color coordinates
- **assembly methods:** suitable for all SMT assembly methods
- s**oldering methods:** IR reflow soldering and TTW soldering
- **preconditioning:** acc. to JEDEC Level 2
- **taping:** 8 mm tape with 2000/reel, ø180 mm or 8000/reel, ø330 mm
- **ESD-withstand voltage:** up to 2 kV acc. to EOS/ESD-5.1-1993

Anwendungen

- Informationsanzeigen im Innenbereich
- Hinterleuchtung (LCD, Schalter, Tasten, Displays, Werbebeleuchtung, Allgemeinbeleuchtung)
- Innenbeleuchtung im Automobilbereich (z.B. Instrumentenbeleuchtung, u.ä.)
- Signal- und Symbolleuchten
- Markierungsbeleuchtung (z.B. Stufen, Fluchtwege, u.ä.)
- Allgemeinbeleuchtung

Applications

- indoor displays
- backlighting (LCD, switches, keys, displays, illuminated advertising, general lighting)
- interior automotive lighting. (e.g. dashboard backlighting, etc.)
- signal and symbol luminaire
- marker lights (e.g. steps, exit ways, etc.)
- general lighting

Typ Type	Emissions-farbe Color of Emission	Farbe der Lichtaustritts-fläche Color of the Light Emitting Area	Lichtstärke Luminous Intensity I_F = 10 mA I_V (mcd)	Lichtstrom Luminous Flux I_F = 10 mA Φ_V (mlm)	Bestellnummer Ordering Code
LW T676-M1N1-25	white	colored	18.0 ... 35.5	77 (typ.)	Q62703Q5107
LW T676-N1P2-25		diffused	28.0 ... 71.0	140 (typ.)	Q62703Q6239

*Anm.: -25 farbselektiert nach Farbortgruppen, Lieferung in Einzelgruppen (siehe **Seite 5**)*

Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe, die aus nur 3 bzw. 4 Halbgruppen besteht. Einzelne Halbgruppen sind nicht erhältlich.
In einer Verpackungseinheit / Gurt ist immer nur eine Halbgruppe enthalten.

*Note: -25 color selection acc. to chromaticity coordinate groups, delivery in single groups (see **page 5**)*

The standard shipping format for serial types includes a lower or upper family group of 3 or 4 individual groups. Individual half groups are not available.
No packing unit / tape ever contains more than one luminous intensity half group.

Grenzwerte
Maximum Ratings

Bezeichnung **Parameter**	**Symbol** **Symbol**	**Wert** **Value**	**Einheit** **Unit**
Betriebstemperatur Operating temperature range	T_{op}	– 40 … + 100	°C
Lagertemperatur Storage temperature range	T_{stg}	– 40 … + 100	°C
Sperrschichttemperatur Junction temperature	T_j	+ 100	°C
Durchlassstrom Forward current	I_F	20	mA
Stoßstrom Surge current $t \leq 10$ µs, $D = 0.005$	I_{FM}	0.2	A
Sperrspannung[1)] Reverse voltage	V_R	12	V
Leistungsaufnahme Power consumption $T_A \leq 25$ °C	P_{tot}	85	mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient Sperrschicht/Lötpad Junction/solder point Montage auf PC-Board FR 4 (Padgröße ≥ 16 mm²) mounted on PC board FR 4 (pad size ≥ 16 mm²)	 $R_{th\ JA}$ $R_{th\ JS}$	 500 280	 K/W K/W

[1)] für kurzzeitigen Betrieb geeignet / suitable for short term application

Kennwerte (T_A = 25 °C)
Characteristics

Bezeichnung **Parameter**		**Symbol** **Symbol**	**Wert** **Value**	**Einheit** **Unit**
Farbkoordinate x nach CIE 1931 [1] Chromaticity coordinate x acc. to CIE 1931 I_F = 10 mA	(typ.)	x	0.30	–
Farbkoordinate y nach CIE 1931[1] Chromaticity coordinate y acc. to CIE 1931 I_F = 10 mA	(typ.)	y	0.32	–
Abstrahlwinkel bei 50 % I_V (Vollwinkel) Viewing angle at 50 % I_V	(typ.)	2φ	120	Grad deg.
Durchlassspannung [2] Forward voltage I_F = 10 mA	(typ.) (max.)	V_F V_F	3.5 4.1	V V
Sperrstrom Reverse current V_R = 12 V	(typ.) (max.)	I_R I_R	0.01 10	µA µA
Temperaturkoeffizient von x Temperature coefficient of x I_F = 10 mA; –10°C ≤ T ≤ 100°C	(typ.)	TC_x	0.07	10^{-3}/K
Temperaturkoeffizient von y Temperature coefficient of y I_F = 10 mA; –10°C ≤ T ≤ 100°C	(typ.)	TC_y	0.25	10^{-3}/K
Temperaturkoeffizient von V_F Temperature coefficient of V_F I_F = 10 mA; –10°C ≤ T ≤ 100°C	(typ.)	TC_V	– 3.1	mV/K
Optischer Wirkungsgrad Optical efficiency I_F = 10 mA	(typ.)	η_{opt}	2	lm/W

[1] Farbortgruppen werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von ±0,01 ermittelt.
Chromaticity coordinate groups are tested at a current pulse duration of 25 ms and a tolerance of ±0.01.

[2] Spannungswerte werden mit einer Stromeinprägedauer von 1 ms und einer Genauigkeit von ±0,1 V ermittelt.
Voltages are tested at a current pulse duration of 1 ms and a tolerance of ±0.1 V.

[1] **Farbortgruppen**
Chromaticity coordinate groups

Gruppe Group	x		y	
	min.	max.	min.	max.
2	0.280	0.305	0.295	0.325
3	0.290	0.315	0.310	0.340
4	0.295	0.320	0.340	0.370
5	0.305	0.330	0.355	0.385

Helligkeits-Gruppierungsschema
Luminous Intensity Groups

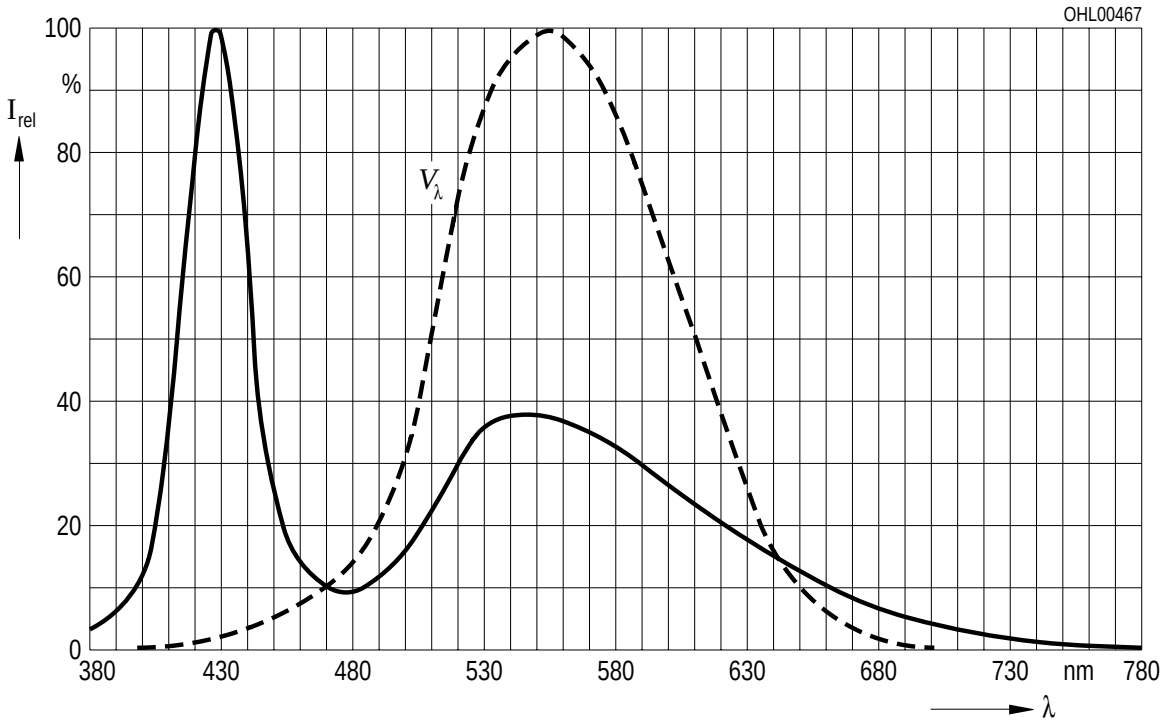
Lichtgruppe Luminous Intensity Group	Lichtstärke Luminous Intensity I_V (mcd)	Lichtstrom Luminous Flux Φ_V (mlm)
M1	18.0 … 22.4	60 (typ.)
M2	22.4 … 28.0	75 (typ.)
N1	28.0 … 35.5	95 (typ.)
N2	35.5 … 45.0	120 (typ.)
P1	45.0 … 56.0	150 (typ.)
P2	56.0 … 71.0	190 (typ.)

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von ± 11% ermittelt.
Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of ± 11%.

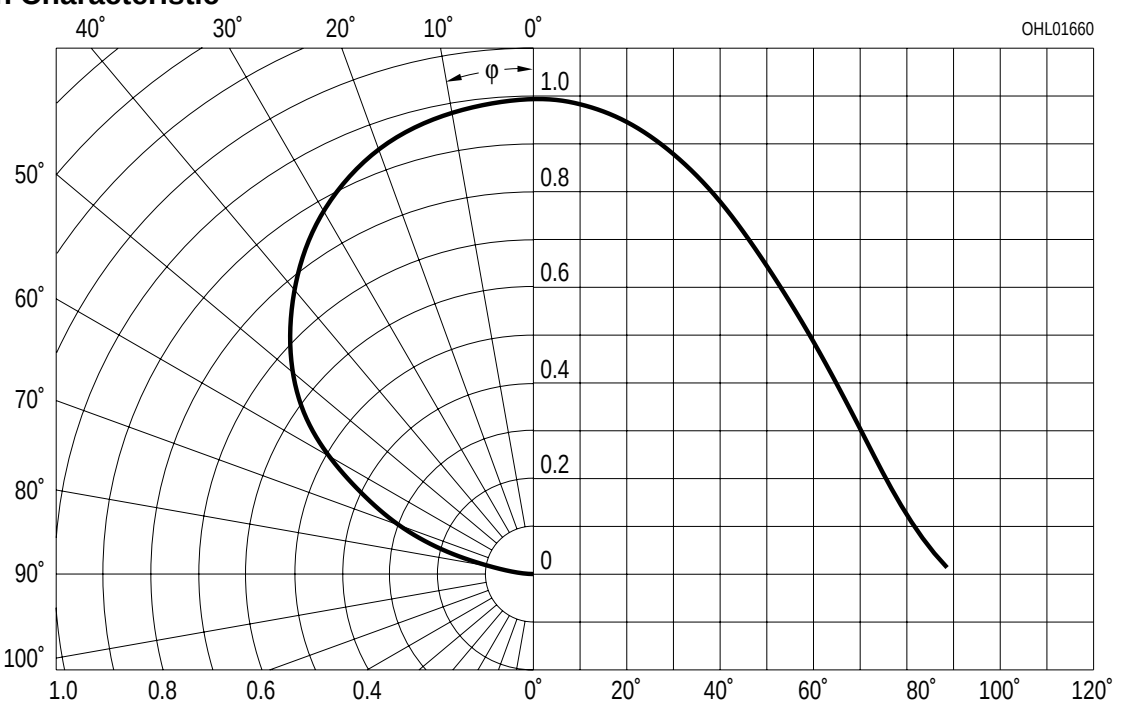
Gruppenbezeichnung auf Etikett
Group Name on Label
Beispiel: N2-4
Example: N2-4

Lichtgruppe Luminous intensity group	Halbgruppe Half group	Farbortgruppe Chromaticity coordinate group
N	2	4

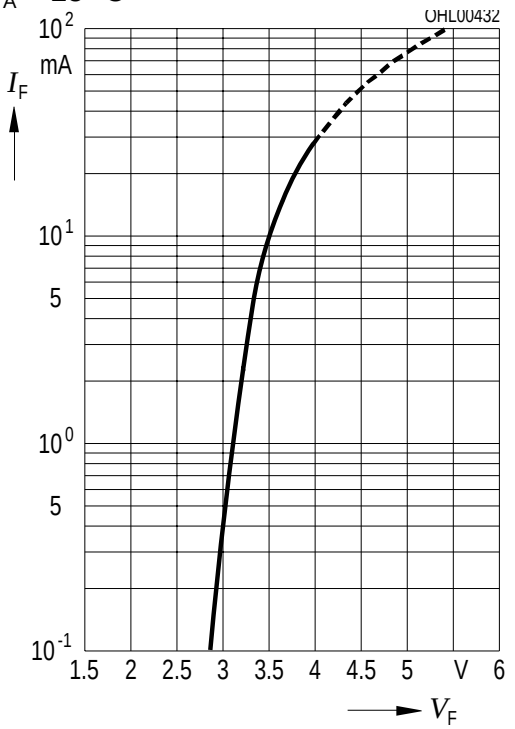
Relative spektrale Emission $I_{rel} = f(\lambda)$, T_A = 25 °C, I_F = 10 mA
Relative Spectral Emission
V(λ) = spektrale Augenempfindlichkeit
Standard eye response curve



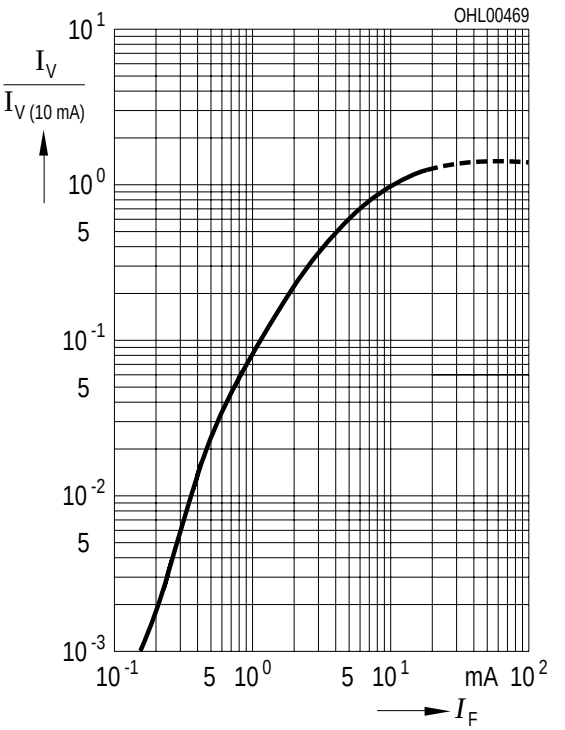
Abstrahlcharakteristik $I_{rel} = f(\varphi)$
Radiation Characteristic



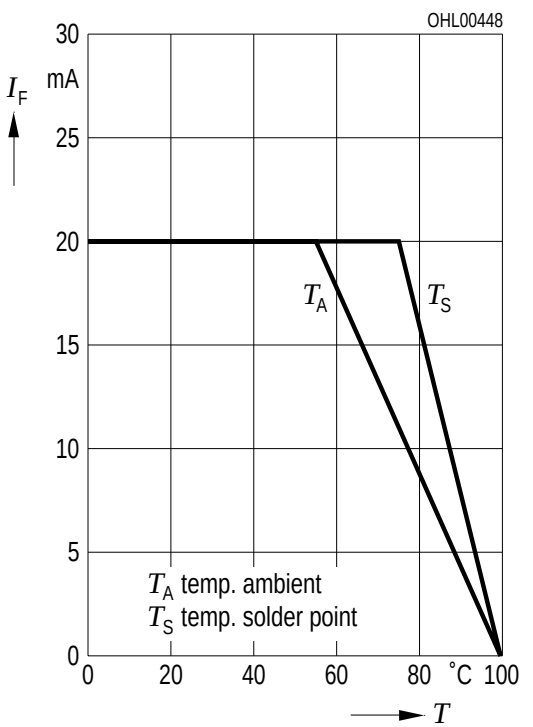
Durchlassstrom $I_F = f(V_F)$
Forward Current
T_A = 25 °C



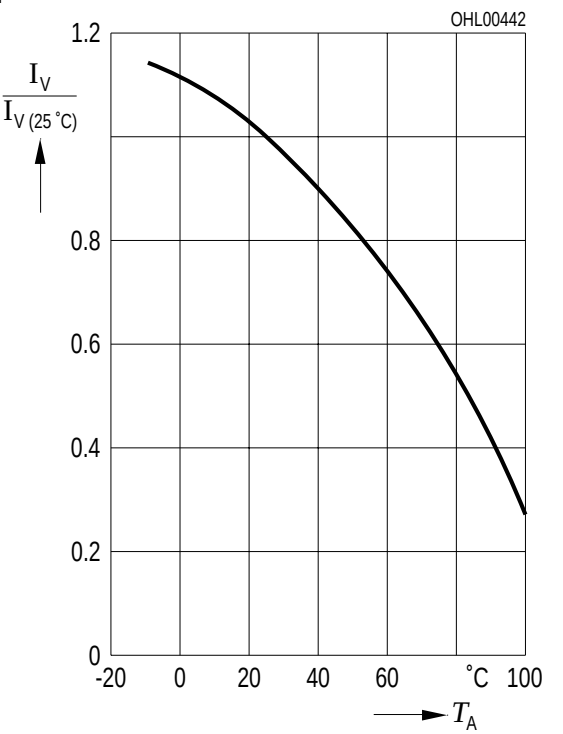
Relative Lichtstärke $I_V/I_{V(10\ mA)} = f(I_F)$
Relative Luminous Intensity
T_A = 25 °C



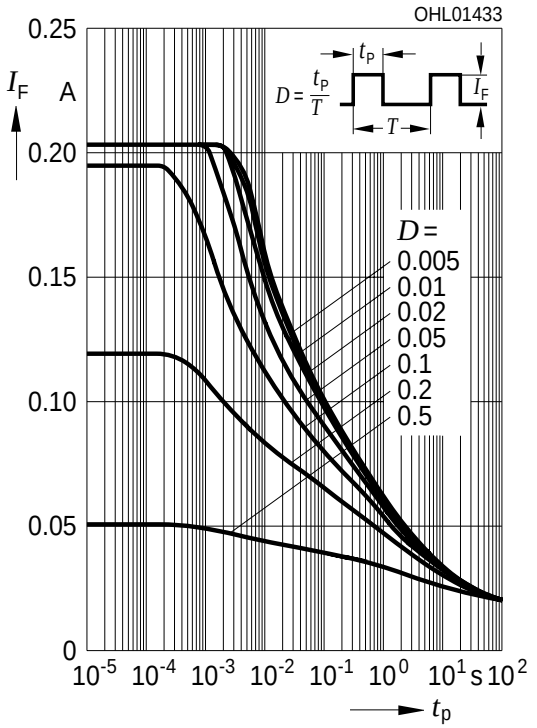
Maximal zulässiger Durchlassstrom $I_F = f(T)$
Max. Permissible Forward Current



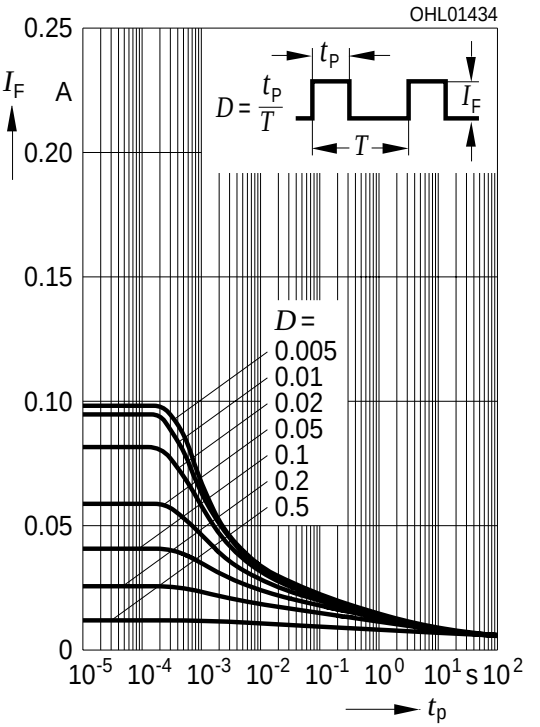
Relative Lichtstärke $I_V/I_{V(25\ °C)} = f(T_A)$
Relative Luminous Intensity
I_F = 10 mA



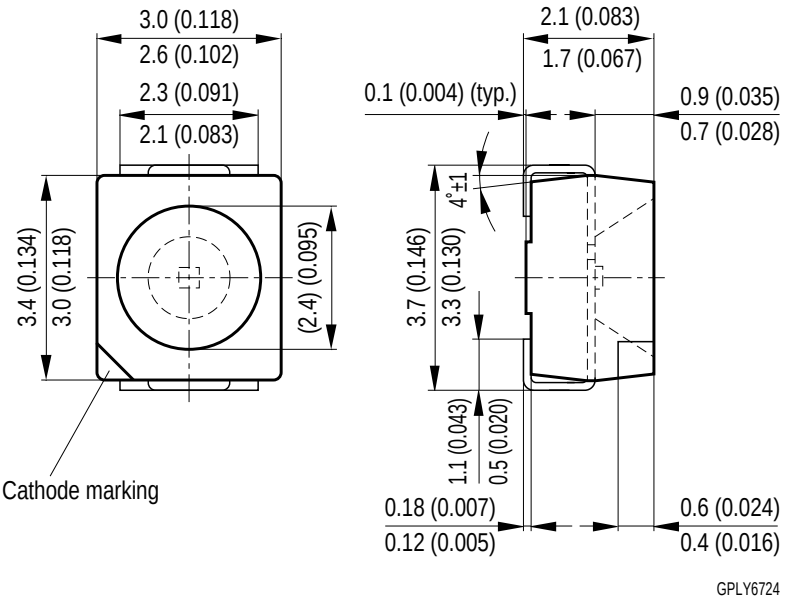
Zulässige Impulsbelastbarkeit $I_F = f(t_p)$
Permissible Pulse Handling Capability
Duty cycle D = parameter, T_A = 25 °C



Zulässige Impulsbelastbarkeit $I_F = f(t_p)$
Permissible Pulse Handling Capability
Duty cycle D = parameter, T_A = 85 °C



Maßzeichnung
Package Outlines

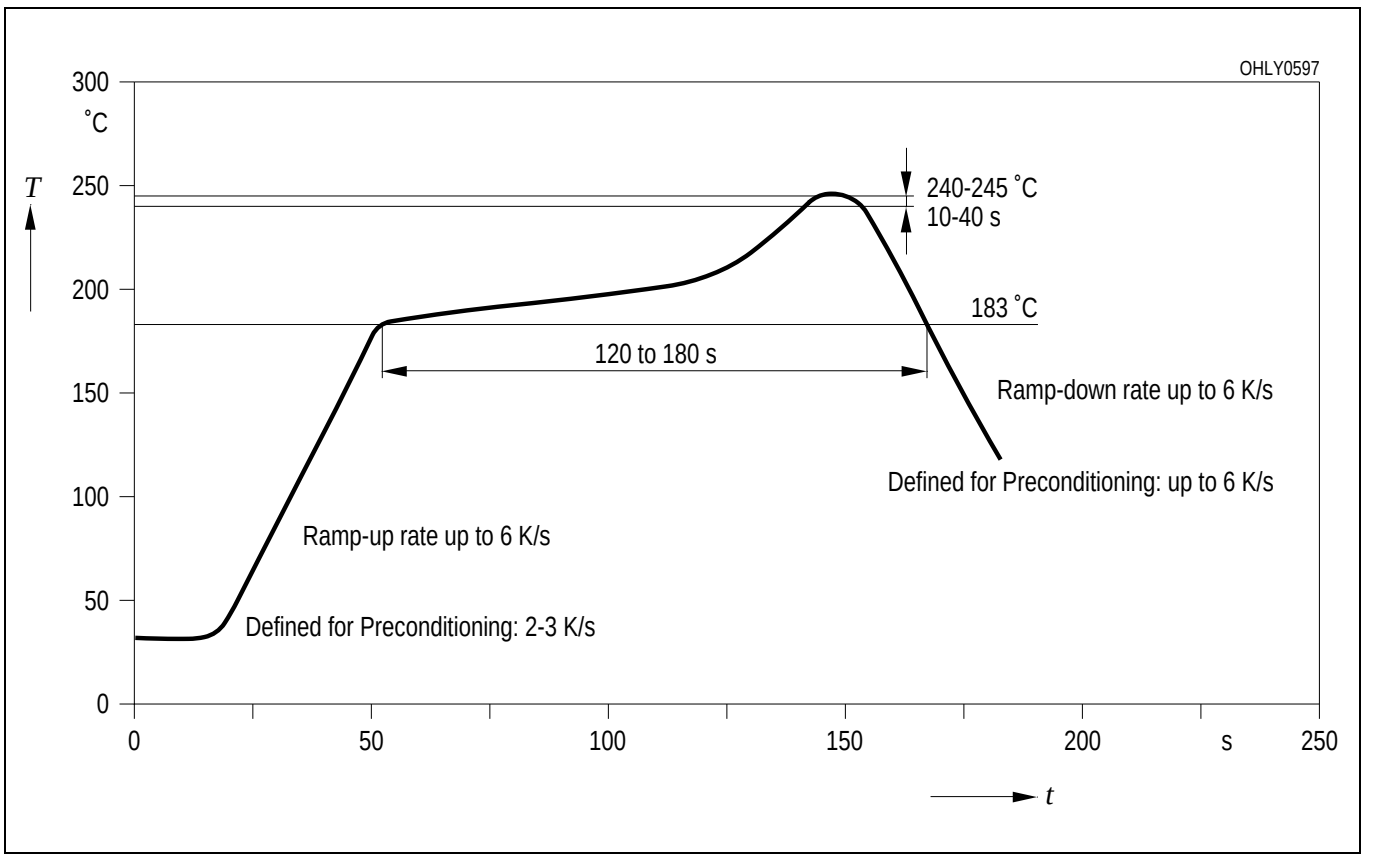


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

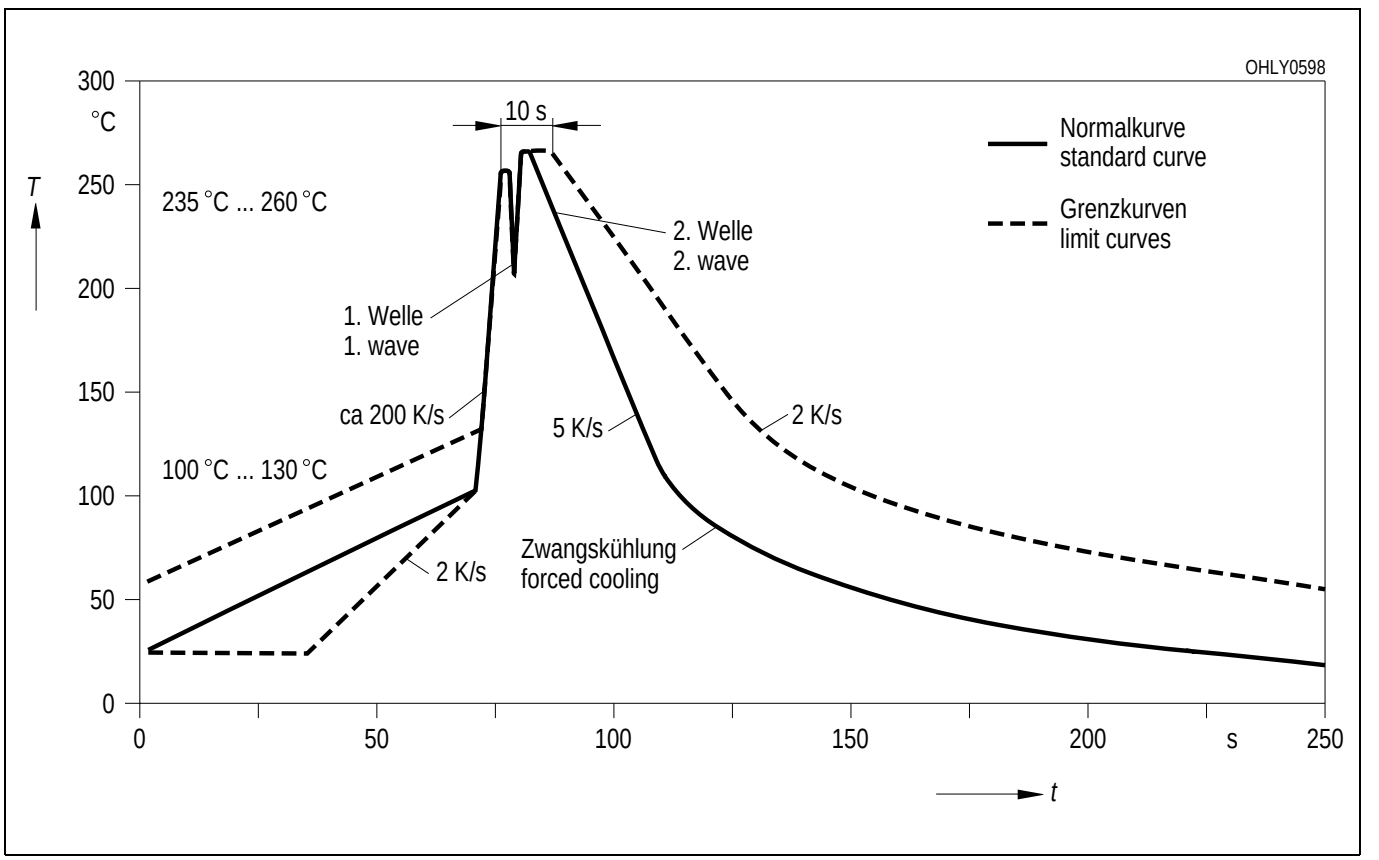
Kathodenkennung: abgeschrägte Ecke
Cathode mark: bevelled edge
Gewicht / Approx. weight: 35 mg

Lötbedingungen Vorbehandlung nach JEDEC Level 2
Soldering Conditions Preconditioning acc. to JEDEC Level 2

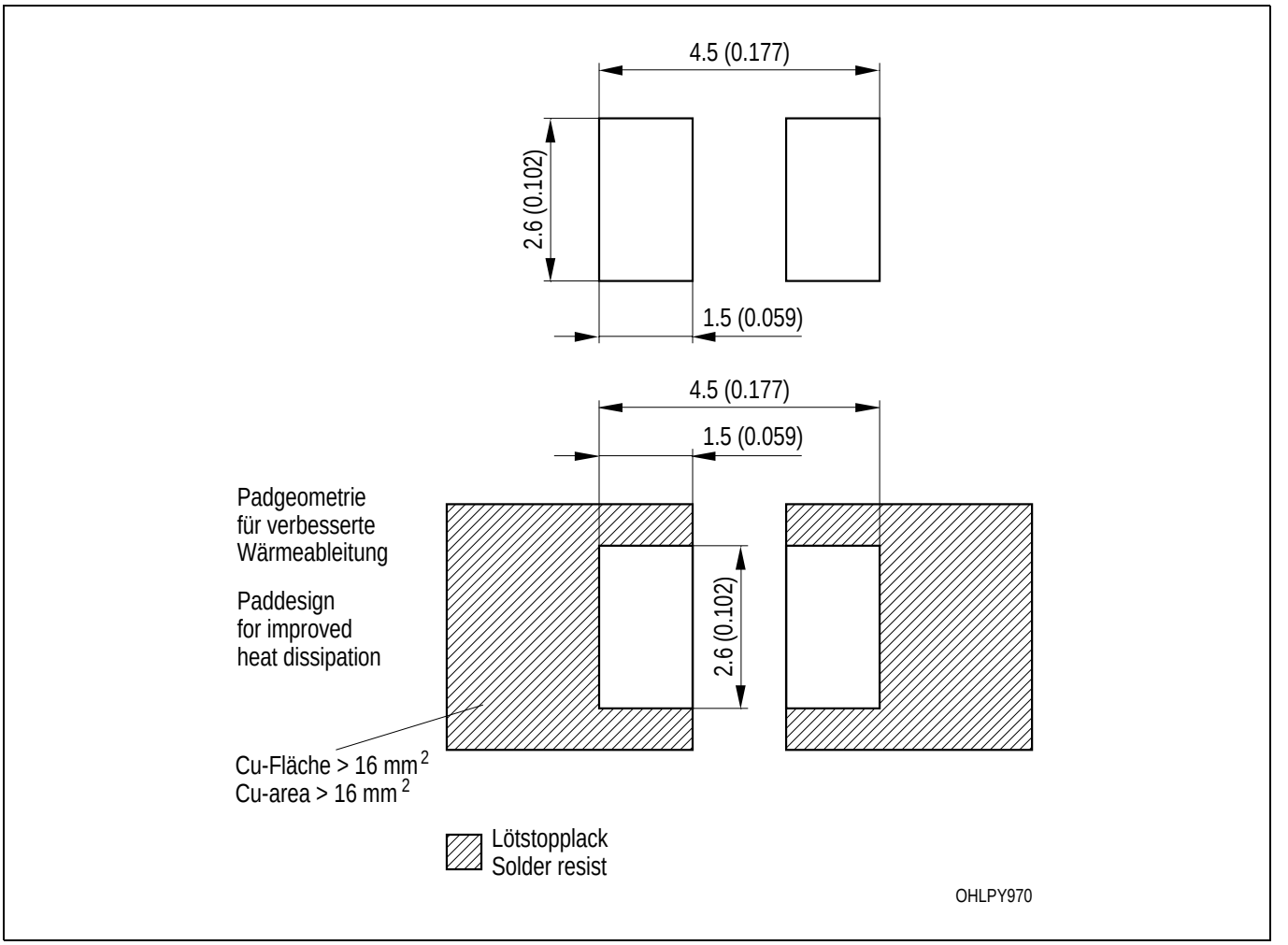
IR-Reflow Lötprofil (nach IPC 9501)
IR Reflow Soldering Profile (acc. to IPC 9501)



Wellenlöten (TTW) (nach CECC 00802)
TTW Soldering (acc. to CECC 00802)

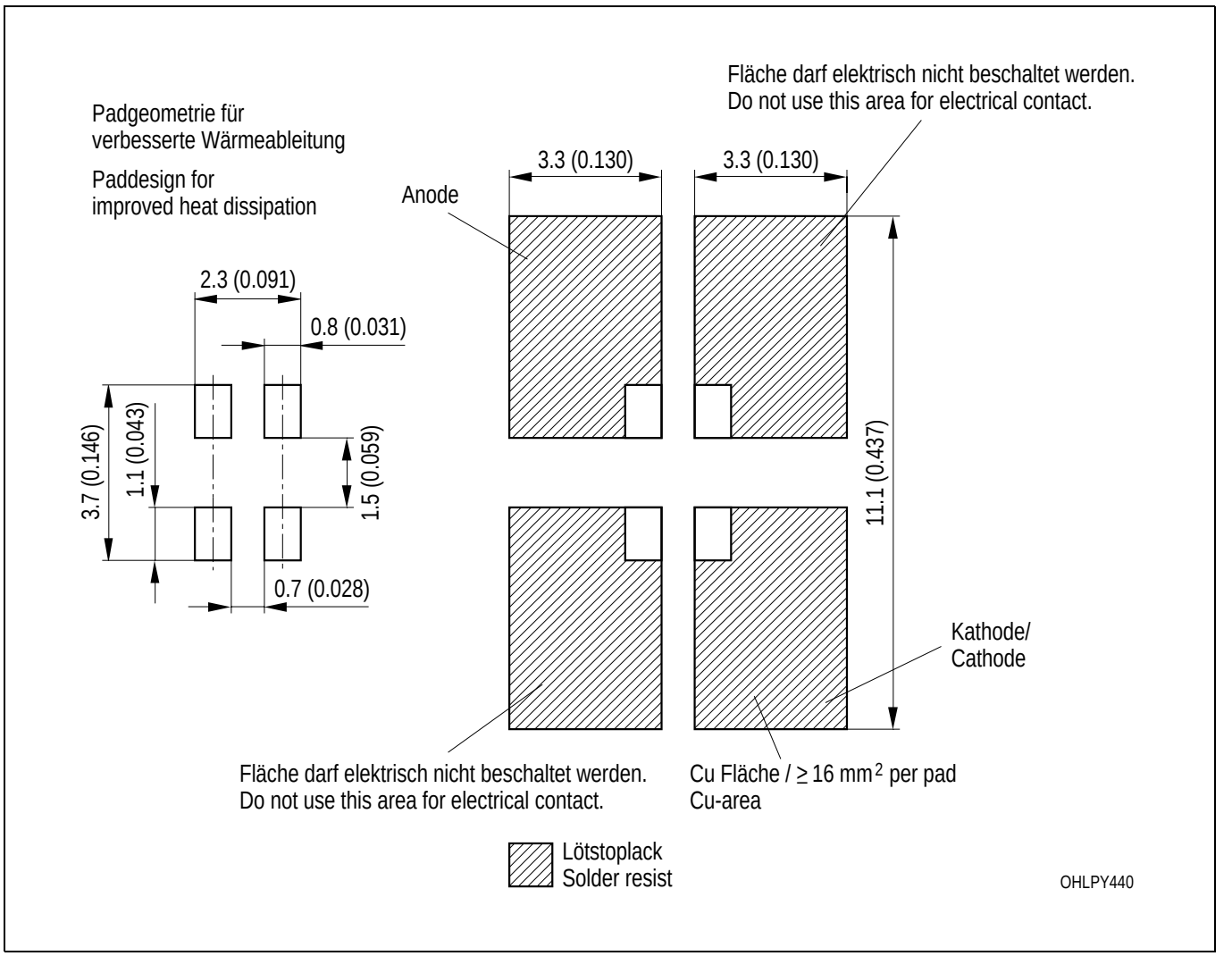


Empfohlenes Lötpaddesign IR Reflow Löten
Recommended Solder Pad IR Reflow Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).
Gehäuse hält TTW-Löthitze aus / Package able to withstand TTW-soldering heat

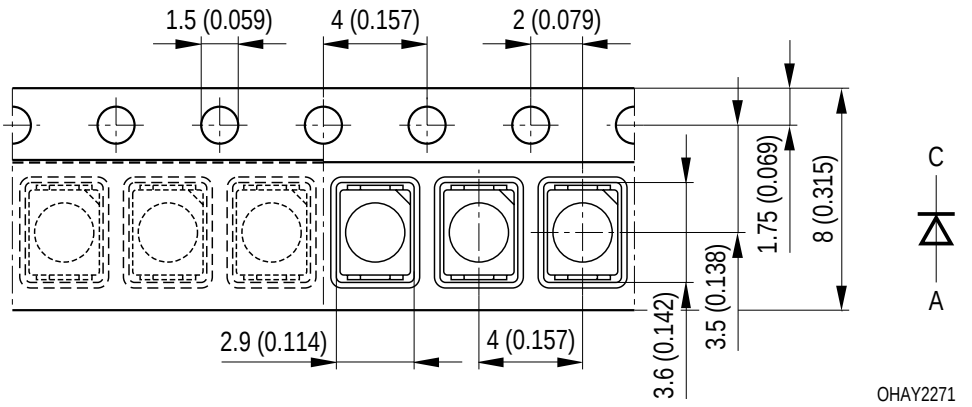
Empfohlenes Lötpaddesign verwendbar für TOPLED® und Power TOPLED®
IR Reflow Löten
Recommended Solder Pad useable for TOPLED® and Power TOPLED®
IR Reflow Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Gurtung / Polarität und Lage
Verpackungseinheit 2000/Rolle, ø180 mm
oder 8000/Rolle, ø330 mm

Method of Taping / Polarity and Orientation
Packing unit 2000/reel, ø180 mm
or 8000/reel, ø330 mm



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Revision History: 2003-03-04		Date of change
Previous Version: 2002-10-18		
Page	**Subjects (major changes since last revision)**	
2	luminous intensity	
5	chromaticity coordinate groups	
3	power consumption from 90 to 85 mW	
2	wavelength grouping for white	
9	change of weight from 40 mg to 35 mg	2002-07-05
14	annotations	2002-07-25
13	recomm. solder pad for TOPLED® and Power TOPLED® (OHLPY440)	2002-08-05
3, 4	value (reverse voltage from 5 V to 12 V)	2002-09-18
2	Ordering Code	2002-09-16
15	new patent no.	2003-03-04

Patent List

Patent No.
US 6 066 861, US 6 277 301, US 6 245 259

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Attention please!
The information describes the type of component and shall not be considered as assured characteristics.
All typical data and graphs are basing on representative samples, but don't represent the production range. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version in the Internet.
Packing
Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.
Components used in life-support devices or systems must be expressly authorized for such purpose! Critical components [1] may only be used in life-support devices or systems [2] with the express written approval of OSRAM OS.
[1] A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.
[2] Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered.